## Rochester Electronics Manufactured Components

Rochester branded components are manufactured using either die/wafers purchased from the original suppliers or Rochester wafers recreated from the original IP. All recreations are done with the approval of the OCM.

Parts are tested using original factory test programs or Rochester developed test solutions to guarantee product meets or exceed the OCM data sheet.

## Quality Overview

- ISO-9001
- AS9120 certification
- Qualified Manufacturers List (QML) MIL-PRF35835
- Class Q Military
- Class V Space Level
- Qualified Suppliers List of Distributors (QSLD)
- Rochester is a critical supplier to DLA and meets all industry and DLA standards.

Rochester Electronics, LLC is committed to supplying products that satisfy customer expectations for quality and are equal to those originally supplied by industry manufacturers.

The original manufacturer's datasheet accompanying this document reflects the performance and specifications of the Rochester manufactured version of this device. Rochester Electronics guarantees the performance of its semiconductor products to the original OEM specifications. 'Typical' values are for reference purposes only. Certain minimum or maximum ratings may be based on product characterization, design, simulation, or sample testing.
$800 \mathrm{MHz}, 50 \mathrm{~mW}$ Current Feedback Amplifier

FEATURES
Excellent Video Specifications ( $\mathrm{R}_{\mathrm{L}}=150 \Omega, \mathrm{G}=+\mathbf{+}$ )
Gain Flatness 0.1 dB to $100 \mathbf{~ M H z}$
0.01\% Differential Gain Error
$0.025^{\circ}$ Differential Phase Error
Low Power
5.5 mA Max Power Supply Current ( 55 mW )

High Speed and Fast Settling
$880 \mathrm{MHz},-3 \mathrm{~dB}$ Bandwidth ( $\mathrm{G}=+1$ )
$440 \mathrm{MHz},-3 \mathrm{~dB}$ Bandwidth ( $\mathrm{G}=+2$ )
1200 V/us Slew Rate
10 ns Settling Time to 0.1\%
Low Distortion
-65 dBc THD, $\mathrm{f}_{\mathrm{C}}=5 \mathrm{MHz}$
33 dBm Third Order Intercept, $\mathrm{F}_{1}=10 \mathrm{MHz}$
-66 dB SFDR, $\mathrm{f}=5 \mathrm{MHz}$
High Output Drive

## 70 mA Output Current

Drives Up to 4 Back-Terminated Loads ( $75 \Omega$ Each)
While Maintaining Good Differential Gain/Phase
Performance ( $0.05 \% / 0.25^{\circ}$ )
APPLICATIONS
A-to-D Drivers
Video Line Drivers
Professional Cameras
Video Switchers
Special Effects
RF Receivers

## GENERAL DESCRIPTION

The AD8001 is a low power, high speed amplifier designed to operate on $\pm 5 \mathrm{~V}$ supplies. The AD8001 features unique


Figure 1. Frequency Response of AD8001
REV. D
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## FUNCTIONAL BLOCK DIAGRAMS

$$
\begin{array}{cc}
\text { 8-Lead PDIP (N-8), } & \text { 5-Lead SOT-23-5 } \\
\text { CERDIP (Q-8) and SOIC (R-8) } & (\text { RT-5 })
\end{array}
$$


transimpedance linearization circuitry. This allows it to drive video loads with excellent differential gain and phase performance on only 50 mW of power. The AD8001 is a current feedback amplifier and features gain flatness of 0.1 dB to 100 MHz while offering differential gain and phase error of $0.01 \%$ and $0.025^{\circ}$. This makes the AD8001 ideal for professional video electronics such as cameras and video switchers. Additionally, the AD8001's low distortion and fast settling make it ideal for buffer high speed A-to-D converters.
The AD8001 offers low power of $5.5 \mathrm{~mA} \max \left(\mathrm{~V}_{\mathrm{S}}= \pm 5 \mathrm{~V}\right)$ and can run on a single +12 V power supply, while being capable of delivering over 70 mA of load current. These features make this amplifier ideal for portable and battery-powered applications where size and power are critical.
The outstanding bandwidth of 800 MHz along with $1200 \mathrm{~V} / \mu \mathrm{s}$ of slew rate make the AD8001 useful in many general-purpose high speed applications where dual power supplies of up to $\pm 6 \mathrm{~V}$ and single supplies from 6 V to 12 V are needed. The AD8001 is available in the industrial temperature range of $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$.


Figure 2. Transient Response of AD8001; 2 V Step, $G=+2$

[^0]| Model |  | Conditions | AD8001A |  |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Min | Typ | Max |  |
| DYNAMIC PERFORMANCE |  |  |  |  |  |  |
| -3 dB Small Signal Bandwidth, | N Package |  | $\mathrm{G}=+2,<0.1 \mathrm{~dB}$ Peaking, $\mathrm{R}_{\mathrm{F}}=750 \Omega$ | 350 | 440 |  | MHz |
|  |  | $\mathrm{G}=+1,<1 \mathrm{~dB}$ Peaking, $\mathrm{R}_{\mathrm{F}}=1 \mathrm{k} \Omega$ | 650 | 880 |  | MHz |
|  | R Package | $\mathrm{G}=+2,<0.1 \mathrm{~dB}$ Peaking, $\mathrm{R}_{\mathrm{F}}=681 \Omega$ | 350 | 440 |  | MHz |
|  |  | $\mathrm{G}=+1,<0.1 \mathrm{~dB}$ Peaking, $\mathrm{R}_{\mathrm{F}}=845 \Omega$ | 575 | 715 |  | MHz |
|  | RT Package | $\mathrm{G}=+2,<0.1 \mathrm{~dB}$ Peaking, $\mathrm{R}_{\mathrm{F}}=768 \Omega$ | 300 | 380 |  | MHz |
|  |  | $\mathrm{G}=+1,<0.1 \mathrm{~dB}$ Peaking, $\mathrm{R}_{\mathrm{F}}=1 \mathrm{k} \Omega$ | 575 | 795 |  | MHz |
| Bandwidth for 0.1 dB Flatness |  |  |  |  |  |  |
|  | N Package | $\mathrm{G}=+2, \mathrm{R}_{\mathrm{F}}=750 \Omega$ $\mathrm{G}=+2, \mathrm{R}_{\mathrm{F}}=681 \Omega$ | 85 100 | 110 125 |  | $\begin{aligned} & \mathrm{MHz} \\ & \mathrm{MHz} \end{aligned}$ |
| Slew Rate $\quad$ RT Package |  | $\mathrm{G}=+2, \mathrm{R}_{\mathrm{F}}=768 \Omega$ | 120 | 145 |  | MHz |
|  |  | $\mathrm{G}=+2, \mathrm{~V}_{\mathrm{O}}=2 \mathrm{~V}$ Step | 800 | 1000 |  | V/us |
| Settling Time to $0.1 \%$ |  | $\mathrm{G}=-1, \mathrm{~V}_{\mathrm{O}}=2 \mathrm{~V}$ Step | 960 | 1200 |  | V/ $/ \mathrm{s}$ |
|  |  | $\mathrm{G}=-1, \mathrm{~V}_{\mathrm{O}}=2 \mathrm{~V}$ Step |  | 10 |  | ns |
| Rise and Fall Time |  | $\mathrm{G}=+2, \mathrm{~V}_{\mathrm{O}}=2 \mathrm{~V}$ Step, $\mathrm{R}_{\mathrm{F}}=649 \Omega$ |  | 1.4 |  | ns |
| NOISE/HARMONIC PERFORMANCE |  |  |  |  |  |  |
| Total Harmonic Distortion |  | $\begin{aligned} & \mathrm{f}_{\mathrm{C}}=5 \mathrm{MHz}, \mathrm{~V}_{\mathrm{O}}=2 \mathrm{~V} \mathrm{p}-\mathrm{p} \\ & \mathrm{G}=+2, \mathrm{R}_{\mathrm{L}}=100 \Omega \end{aligned}$ |  | -65 |  | dBc |
| Input Voltage Noise |  | $\mathrm{f}=10 \mathrm{kHz}$ |  | 2.0 |  | $\mathrm{nV} / \sqrt{\mathrm{Hz}}$ |
| Input Current Noise |  | $\mathrm{f}=10 \mathrm{kHz},+\mathrm{In}$ |  | 2.0 |  | $\mathrm{pA} / \sqrt{\mathrm{Hz}}$ |
|  |  | -In |  | 18 |  | $\mathrm{pA} / \sqrt{\mathrm{Hz}}$ |
| Differential Gain Error |  | NTSC, $\mathrm{G}=+2, \mathrm{R}_{\mathrm{L}}=150 \Omega$ |  | 0.01 | 0.025 |  |
| Differential Phase Error |  | NTSC, $\mathrm{G}=+2, \mathrm{R}_{\mathrm{L}}=150 \Omega$ |  | 0.025 | 0.04 | Degree |
| Third Order Intercept |  | $\mathrm{f}=10 \mathrm{MHz}$ |  | 33 |  | dBm |
| 1 dB Gain Compression |  | $\mathrm{f}=10 \mathrm{MHz}$ |  | 14 |  | dBm |
| SFDR |  | $\mathrm{f}=5 \mathrm{MHz}$ |  | -66 |  | dB |
| DC PERFORMANCE |  |  |  |  |  |  |
| Input Offset Voltage |  |  |  | 2.0 | 5.5 | mV |
|  |  | $\mathrm{T}_{\text {MIN }}-\mathrm{T}_{\text {MAX }}$ |  | 2.0 | 9.0 | mV |
| Offset Drift |  |  |  | 10 |  | $\mu \mathrm{V} /{ }^{\circ} \mathrm{C}$ |
| -Input Bias Current |  |  |  | 5.0 | 25 | $\pm \mu \mathrm{A}$ |
| +Input Bias Current |  | $\mathrm{T}_{\text {MIN }}-\mathrm{T}_{\text {MAX }}$ |  |  | 35 | $\pm \mu \mathrm{A}$ |
|  |  |  |  | 3.0 | 6.0 | $\pm \mu \mathrm{A}$ |
| Open-Loop Transresistance |  | $\mathrm{T}_{\text {MIN }}-\mathrm{T}_{\text {MAX }}$ |  |  | 10 | $\pm \mu \mathrm{A}$ |
|  |  | $\mathrm{V}_{\mathrm{O}}= \pm 2.5 \mathrm{~V}$ | 250 | 900 |  | $\mathrm{k} \Omega$ |
|  |  | $\mathrm{T}_{\text {MIN }}-\mathrm{T}_{\text {MAX }}$ | 175 |  |  | k $\Omega$ |
| INPUT CHARACTERISTICS |  |  |  |  |  |  |
| Input Resistance |  | +Input |  | 10 |  | $\mathrm{M} \Omega$ |
|  |  | -Input |  | 50 |  | $\Omega$ |
| Input Capacitance |  | +Input |  | 1.5 |  | pF |
| Input Common-Mode Voltage Range |  |  |  | 3.2 |  | $\pm \mathrm{V}$ |
| Common-Mode Rejection Ratio |  |  |  |  |  |  |
| Offset Voltage |  | $\mathrm{V}_{\mathrm{CM}}= \pm 2.5 \mathrm{~V}$ | 50 | 54 |  | dB |
| -Input Current |  | $\mathrm{V}_{\mathrm{CM}}= \pm 2.5 \mathrm{~V}, \mathrm{~T}_{\text {MIN }}-\mathrm{T}_{\mathrm{MAX}}$ |  | 0.3 | 1.0 | $\mu \mathrm{A} / \mathrm{V}$ |
| +Input Current |  | $\mathrm{V}_{\mathrm{CM}}= \pm 2.5 \mathrm{~V}, \mathrm{~T}_{\text {MIN }}-\mathrm{T}_{\mathrm{MAX}}$ |  | 0.2 | 0.7 | $\mu \mathrm{A} / \mathrm{V}$ |
| OUTPUT CHARACTERISTICS |  |  |  |  |  |  |
| Output Voltage Swing |  | $\mathrm{R}_{\mathrm{L}}=150 \Omega$ | 2.7 | 3.1 |  | $\pm \mathrm{V}$ |
| Output Current |  | $\mathrm{R}_{\mathrm{L}}=37.5 \Omega$ | 50 | 70 |  | mA |
| Short Circuit Current |  |  | 85 | 110 |  | mA |
| POWER SUPPLY |  |  |  |  |  |  |
| Operating Range |  |  | $\pm 3.0$ |  | $\pm 6.0$ | V |
| Quiescent Current |  | $\mathrm{T}_{\text {MIN }}-\mathrm{T}_{\text {MAX }}$ |  | 5.0 | 5.5 | mA |
| Power Supply Rejection Ratio |  | $+\mathrm{V}_{\mathrm{S}}=+4 \mathrm{~V}$ to $+6 \mathrm{~V},-\mathrm{V}_{\mathrm{S}}=-5 \mathrm{~V}$ | 60 | 75 |  | dB |
|  |  | $-\mathrm{V}_{\mathrm{S}}=-4 \mathrm{~V}$ to $-6 \mathrm{~V},+\mathrm{V}_{\mathrm{S}}=+5 \mathrm{~V}$ | 50 | 56 |  | dB |
|  |  | $\mathrm{T}_{\text {MIN }}-\mathrm{T}_{\text {MAX }}$ |  | 0.5 | 2.5 | $\mu \mathrm{A} / \mathrm{V}$ |
| +Input Current |  | $\mathrm{T}_{\text {MIN }}{ }^{-} \mathrm{T}_{\text {MAX }}$ |  | 0.1 | 0.5 | $\mu \mathrm{A} / \mathrm{V}$ |

[^1]
## ABSOLUTE MAXIMUM RATINGS ${ }^{1}$


SOIC (R) . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . 0.8 W

$$
\text { 8-Lead CERDIP . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . } 1.1 \text { W }
$$

$$
\text { SOT-23-5 Package (RT) . . . . . . . . . . . . . . . . . . . . . . . . } 0.5 \text { W }
$$

## MAXIMUM POWER DISSIPATION

The maximum power that can be safely dissipated by the AD8001 is limited by the associated rise in junction temperature. The maximum safe junction temperature for plastic encapsulated devices is determined by the glass transition temperature of the plastic, approximately $150^{\circ} \mathrm{C}$. Exceeding this limit temporarily may cause a shift in parametric performance due to a change in the stresses exerted on the die by the package. Exceeding a junction temperature of $175^{\circ} \mathrm{C}$ for an extended period can result in device failure.

While the AD8001 is internally short circuit protected, this may not be sufficient to guarantee that the maximum junction temperature $\left(150^{\circ} \mathrm{C}\right)$ is not exceeded under all conditions. To ensure proper operation, it is necessary to observe the maximum power derating curves.


Figure 3. Plot of Maximum Power Dissipation vs. Temperature

## ORDERING GUIDE

| Model | Temperature Range | Package Description | Package Option | Branding |
| :---: | :---: | :---: | :---: | :---: |
| AD8001AN | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 8-Lead PDIP | N-8 |  |
| AD8001AQ | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | 8-Lead CERDIP | Q-8 |  |
| AD8001AR | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 8-Lead SOIC | R-8 |  |
| AD8001AR-REEL | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 13" Tape and REEL | R-8 |  |
| AD8001AR-REEL7 | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 7" Tape and REEL | R-8 |  |
| AD8001ART-REEL | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 13" Tape and REEL | RT-5 | HEA |
| AD8001ART-REEL7 | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 7" Tape and REEL | RT-5 | HEA |
| AD8001ACHIPS | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | Die Form |  |  |
| 5962-9459301MPA* | $-55^{\circ} \mathrm{C}$ to $+125^{\circ} \mathrm{C}$ | 8-Lead CERDIP | Q-8 |  |

*Standard Military Drawing Device.

## CAUTION

ESD (electrostatic discharge) sensitive device. Electrostatic charges as high as 4000 V readily accumulate on the human body and test equipment and can discharge without detection. Although the AD8001 features proprietary ESD protection circuitry, permanent damage may occur on devices subjected to high energy electrostatic discharges. Therefore, proper ESD precautions are recommended to avoid performance degradation or loss of functionality.

## AD8001-Typical Performance Characteristics



TPC 1. Test Circuit, Gain $=+2$


TPC 2. 1 V Step Response, $G=+2$


TPC 3. 2 V Step Response, $G=+1$


TPC 4. 2 V Step Response, $G=+2$


TPC 5. Test Circuit, Gain $=+1$


TPC 6. 100 mV Step Response, $G=+1$


TPC 7. Frequency Response, $G=+2$


TPC 8. 0.1 dB Flatness, $R$ Package (for $N$ Package Add $50 \Omega$ to $R_{F}$ )


TPC 9. Distortion vs. Frequency, $R_{L}=1 \mathrm{k} \Omega$


TPC 10. $-3 d B$ Bandwidth vs. $R_{F}$


TPC 11. Distortion vs. Frequency, $R_{L}=100 \Omega$


TPC 12. Differential Gain and Differential Phase


TPC 13. Frequency Response, $G=+1$


TPC 14. Flatness, $R$ Package, $G=+1$ (for $N$ Package Add $100 \Omega$ to $R_{F}$ )


TPC 15. Distortion vs. Frequency, $R_{L}=1 \mathrm{k} \Omega$


TPC 16. $-3 d B$ Bandwidth vs. $R_{F}, G=+1$


TPC 17. Distortion vs. Frequency, $R_{L}=100 \Omega$


TPC 18. Large Signal Frequency Response, $G=+1$


TPC 19. Frequency Response, $G=+10, G=+100$


TPC 20. Output Swing vs. Temperature


TPC 21. Input Bias Current vs. Temperature


TPC 22. Input Offset vs. Temperature


TPC 23. Supply Current vs. Temperature


TPC 24. Short Circuit Current vs. Temperature


TPC 25. Transresistance vs. Temperature


TPC 26. Noise vs. Frequency


TPC 27. CMRR vs. Temperature


TPC 28. Output Resistance vs. Frequency


TPC 29. $-3 d B$ Bandwidth vs. Frequency, $G=-1$


TPC 30. PSRR vs. Temperature


TPC 31. CMRR vs. Frequency


TPC 32. $-3 d B$ Bandwidth vs. Frequency, $G=-2$


TPC 33. 100 mV Step Response, $G=-1$


TPC 34. PSRR vs. Frequency


TPC 35. 2 V Step Response, $G=-1$


TPC 36. Input Offset Voltage Distribution

## AD8001

## THEORY OF OPERATION

A very simple analysis can put the operation of the AD8001, a current feedback amplifier, in familiar terms. Being a current feedback amplifier, the AD8001's open-loop behavior is expressed as transimpedance, $\Delta \mathrm{V}_{\mathrm{O}} / \Delta \mathrm{I}_{-\mathrm{IN}}$, or $T_{Z}$. The open-loop transimpedance behaves just as the open-loop voltage gain of a voltage feedback amplifier, that is, it has a large dc value and decreases at roughly $6 \mathrm{~dB} /$ octave in frequency.
Since the $R_{I N}$ is proportional to $1 / g_{M}$, the equivalent voltage gain is just $T_{Z} \times g_{M}$, where the $g_{M}$ in question is the transconductance of the input stage. This results in a low open-loop input impedance at the inverting input, a now familiar result. Using this amplifier as a follower with gain, Figure 4, basic analysis yields the following result.

$$
\begin{aligned}
& \frac{V_{O}}{V_{I N}}=G \times \frac{T_{Z}(S)}{T_{Z}(S)+G \times R_{I N}+R 1} \\
& G=1+\frac{R 1}{R 2} \quad R_{I N}=1 / g_{M} \approx 50 \Omega
\end{aligned}
$$



Figure 4. Follower with Gain
Recognizing that $G \times R_{I N} \ll R 1$ for low gains, it can be seen to the first order that bandwidth for this amplifier is independent of gain (G). This simple analysis in conjunction with Figure 5 can, in fact, predict the behavior of the AD8001 over a wide range of conditions.


Figure 5. Transimpedance vs. Frequency

Considering that additional poles contribute excess phase at high frequencies, there is a minimum feedback resistance below which peaking or oscillation may result. This fact is used to determine the optimum feedback resistance, $\mathrm{R}_{\mathrm{F}}$. In practice, parasitic capacitance at Pin 2 will also add phase in the feedback loop, so picking an optimum value for $\mathrm{R}_{\mathrm{F}}$ can be difficult. Figure 6 illustrates this problem. Here the fine scale $(0.1 \mathrm{~dB} /$ div) flatness is plotted versus feedback resistance. These plots were taken using an evaluation card which is available to customers so that these results may readily be duplicated.
Achieving and maintaining gain flatness of better than 0.1 dB at frequencies above 10 MHz requires careful consideration of several issues.


Figure 6. 0.1 dB Flatness vs. Frequency

## Choice of Feedback and Gain Resistors

Because of the above-mentioned relationship between the bandwidth and feedback resistor, the fine scale gain flatness will, to some extent, vary with feedback resistance. It, therefore, is recommended that once optimum resistor values have been determined, $1 \%$ tolerance values should be used if it is desired to maintain flatness over a wide range of production lots. In addition, resistors of different construction have different associated parasitic capacitance and inductance. Surface-mount resistors were used for the bulk of the characterization for this data sheet. It is not recommended that leaded components be used with the AD8001.

## Printed Circuit Board Layout Considerations

As to be expected for a wideband amplifier, PC board parasitics can affect the overall closed-loop performance. Of concern are stray capacitances at the output and the inverting input nodes. If a ground plane is to be used on the same side of the board as the signal traces, a space ( 5 mm min ) should be left around the signal lines to minimize coupling. Additionally, signal lines connecting the feedback and gain resistors should be short enough so that their associated inductance does not cause high frequency gain errors. Line lengths on the order of less than 5 mm are recommended. If long runs of coaxial cable are being driven, dispersion and loss must be considered.

## Power Supply Bypassing

Adequate power supply bypassing can be critical when optimizing the performance of a high frequency circuit. Inductance in the power supply leads can form resonant circuits that produce peaking in the amplifier's response. In addition, if large current transients must be delivered to the load, then bypass capacitors (typically greater than $1 \mu \mathrm{~F}$ ) will be required to provide the best settling time and lowest distortion. A parallel combination of $4.7 \mu \mathrm{~F}$ and $0.1 \mu \mathrm{~F}$ is recommended. Some brands of electrolytic capacitors will require a small series damping resistor $\approx 4.7 \Omega$ for optimum results.

## DC Errors and Noise

There are three major noise and offset terms to consider in a current feedback amplifier. For offset errors, refer to the equation below. For noise error the terms are root-sum-squared to give a net output error. In the circuit in Figure 7 they are input offset ( $\mathrm{V}_{\mathrm{IO}}$ ), which appears at the output multiplied by the noise gain of the circuit ( $1+\mathrm{R}_{\mathrm{F}} / \mathrm{R}_{\mathrm{I}}$ ), noninverting input current $\left(\mathrm{I}_{\mathrm{BN}} \times \mathrm{R}_{\mathrm{N}}\right)$ also multiplied by the noise gain, and the inverting input current, which when divided between $R_{F}$ and $R_{I}$ and subsequently multiplied by the noise gain always appears at the output as $\mathrm{I}_{\mathrm{BN}} \times \mathrm{R}_{\mathrm{F}}$. The input voltage noise of the AD 8001 is a low $2 \mathrm{nV} /$ $\sqrt{\mathrm{Hz}}$. At low gains though the inverting input current noise times $\mathrm{R}_{\mathrm{F}}$ is the dominant noise source. Careful layout and device matching contribute to better offset and drift specifications for the AD8001 compared to many other current feedback amplifiers. The typical performance curves in conjunction with the following equations can be used to predict the performance of the AD8001 in any application.

$$
V_{O U T}=V_{I O} \times\left(1+\frac{R_{F}}{R_{I}}\right) \pm I_{B N} \times R_{N} \times\left(1+\frac{R_{F}}{R_{I}}\right) \pm I_{B I} \times R_{F}
$$



Figure 7. Output Offset Voltage

## Driving Capacitive Loads

The AD8001 was designed primarily to drive nonreactive loads. If driving loads with a capacitive component is desired, best frequency response is obtained by the addition of a small series resistance, as shown in Figure 8. The accompanying graph shows the optimum value for $\mathrm{R}_{\text {SERIES }}$ versus capacitive load. It is worth noting that the frequency response of the circuit when driving large capacitive loads will be dominated by the passive roll-off of $\mathrm{R}_{\text {SERIES }}$ and $\mathrm{C}_{\mathrm{L}}$.


Figure 8. Driving Capacitive Loads


Figure 9. Recommended $R_{\text {SERIES }}$ vs. Capacitive Load

## AD8001

## Communications

Distortion is a key specification in communications applications. Intermodulation distortion (IMD) is a measure of the ability of an amplifier to pass complex signals without the generation of spurious harmonics. The third order products are usually the most problematic since several of them fall near the fundamentals and do not lend themselves to filtering. Theory predicts that the third order harmonic distortion components increase in power at three times the rate of the fundamental tones. The specification of third order intercept as the virtual point where fundamental and harmonic power are equal is one standard measure of distortion performance. Op amps used in closed-loop applications do not always obey this simple theory. At a gain of +2 , the AD8001 has performance summarized in Figure 10. Here the worst third order products are plotted versus input power. The third order intercept of the AD 8001 is +33 dBm at 10 MHz .


Figure 10. Third Order IMD; $F_{1}=10 \mathrm{MHz}, F_{2}=12 \mathrm{MHz}$

## Operation as a Video Line Driver

The AD8001 has been designed to offer outstanding performance as a video line driver. The important specifications of differential gain $(0.01 \%)$ and differential phase $\left(0.025^{\circ}\right)$ meet the most exacting HDTV demands for driving one video load. The AD8001 also drives up to two back terminated loads as shown in Figure 11, with equally impressive performance ( $0.01 \%$, $0.07^{\circ}$ ). Another important consideration is isolation between loads in a multiple load application. The AD8001 has more than 40 dB of isolation at 5 MHz when driving two $75 \Omega$ back terminated loads.


Figure 11. Video Line Driver

## Driving A-to-D Converters

The AD8001 is well suited for driving high speed analog-todigital converters such as the AD9058. The AD9058 is a dual 8 -bit 50 MSPS ADC. In the circuit below, the AD8001 is shown driving the inputs of the AD 9058 , which are configured for 0 V to 2 V ranges. Bipolar input signals are buffered, amplified $(-2 \times)$, and offset (by +1.0 V ) into the proper input range of the

ADC. Using the AD9058's internal +2 V reference connected to both ADCs as shown in Figure 12 reduces the number of external components required to create a complete data acquisition system. The $20 \Omega$ resistors in series with ADC inputs are used to help the AD8001s drive the 10 pF ADC input capacitance. The AD8001 only adds 100 mW to the power consumption while not limiting the performance of the circuit.


Figure 12. AD8001 Driving a Dual A-to-D Converter

## AD8001

## Layout Considerations

The specified high speed performance of the AD8001 requires careful attention to board layout and component selection. Proper $\mathrm{R}_{\mathrm{F}}$ design techniques and low parasitic component selection are mandatory.

The PCB should have a ground plane covering all unused portions of the component side of the board to provide a low impedance ground path. The ground plane should be removed from the area near the input pins to reduce stray capacitance.

Chip capacitors should be used for supply bypassing (see Figure 13). One end should be connected to the ground plane and the other within $1 / 8$ inch of each power pin. An additional large
$(4.7 \mu \mathrm{~F}-10 \mu \mathrm{~F})$ tantalum electrolytic capacitor should be connected in parallel, but not necessarily so close, to supply current for fast, large-signal changes at the output.
The feedback resistor should be located close to the inverting input pin in order to keep the stray capacitance at this node to a minimum. Capacitance variations of less than 1 pF at the inverting input will significantly affect high speed performance.
Stripline design techniques should be used for long signal traces (greater than about 1 inch). These should be designed with a characteristic impedance of $50 \Omega$ or $75 \Omega$ and be properly terminated at each end.


Figure 13. Inverting and Noninverting Configurations for Evaluation Boards

Table I. Recommended Component Values

|  | AD8001AN (PDIP) Gain |  |  |  |  | AD8001AR (SOIC) Gain |  |  |  |  | GainAD8001ART (SOT-23-5)Gater |  |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Component | -1 | +1 | +2 | +10 | +100 | -1 | +1 | +2 | +10 | +100 | -1 | +1 | +2 | +10 | +100 |
| $\mathrm{R}_{\mathrm{F}}(\Omega)$ | 649 | 1050 | 750 | 470 | 1000 | 604 | 953 | 681 | 470 | 1000 | 845 | 1000 | 768 | 470 | 1000 |
| $\mathrm{R}_{\mathrm{G}}(\Omega)$ | 649 |  | 750 | 51 | 10 | 604 |  | 681 | 51 | 10 | 845 |  | 768 | 51 | 10 |
| $\mathrm{R}_{\mathrm{O}}($ Nominal $)(\Omega)$ | 49.9 | 49.9 | 49.9 | 49.9 | 49.9 | 49.9 | 49.9 | 49.9 | 49.9 | 49.9 | 49.9 | 49.9 | 49.9 | 49.9 | 49.9 |
| $\mathrm{R}_{\mathrm{S}}(\Omega)$ | 0 |  |  |  |  | 0 |  |  |  |  | 0 |  |  |  |  |
| $\mathrm{R}_{\mathrm{T}}$ (Nominal) ( $\Omega$ ) | 54.9 | 49.9 | 49.9 | 49.9 | 49.9 | 54.9 | 49.9 | 49.9 | 49.9 | 49.9 | 54.9 | 49.9 | 49.9 | 49.9 | 49.9 |
| Small Signal BW (MHz) | 340 | 880 | 460 | 260 | 20 | 370 | 710 | 440 | 260 | 20 | 240 | 795 | 380 | 260 | 20 |
| 0.1 dB Flatness (MHz) | 105 | 70 | 105 |  |  | 130 | 100 | 120 |  |  | 110 | 300 | 145 |  |  |

## OUTLINE DIMENSIONS

## 8-Lead Plastic Dual In-Line Package [PDIP] <br> ( $\mathrm{N}-8$ )

Dimensions shown in inches and (millimeters)


## 8-Lead Standard Small Outline Package [SOIC] <br> (R-8)

Dimensions shown in millimeters and (inches)


8-Lead Ceramic Dual In-Line Package [CERDIP] (Q-8)
Dimensions shown in inches and (millimeters)


CONTROLLING DIMENSIONS ARE IN INCHES; MILLIMETERS DIMENSIONS (IN PARENTHESES) ARE ROUNDED-OFF INCH EQUIVALENTS FOR REFERENCE ONLY AND ARE NOT APPROPRIATE FOR USE IN DESIGN

5-Lead Small Outline Transistor Package [SOT-23]
(RT-5)
Dimensions shown in millimeters


COMPLIANT TO JEDEC STANDARDS MO-178AA

## Revision History

Location Page
7103-Data Sheet changed from REV. C to REV. D
Renumbered figures and TPCs ..... Universal
Changes to ORDERING GUIDE .....  3
Updated OUTLINE DIMENSIONS ..... 15


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[^1]:    Specifications subject to change without notice.

